

## Dual N-Channel Advanced Power MOSFET

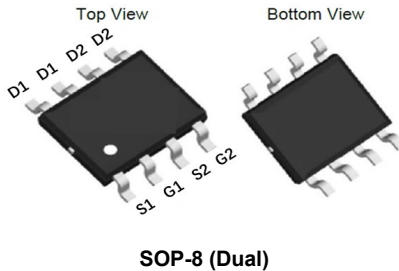
### Features

- $V_{DS} = 100V$ ,  $I_D = 12 A$   
 $R_{DS(ON)} < 12 m\Omega @ V_{GS} = 10V$   
 $R_{DS(ON)} < 14 m\Omega @ V_{GS} = 4.5V$

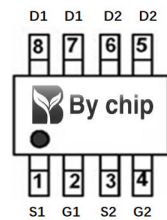
### General Features

- Advanced Trench Technology
- Provide Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free and Green Available

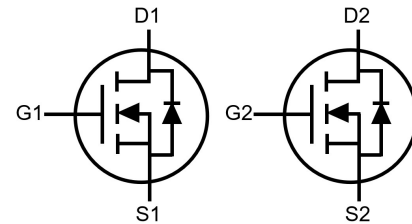
100% UIS TESTED!  
 100%  $\Delta V_{ds}$  TESTED!



SOP-8 (Dual)



Pin Assignment



Schematic diagram

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted)				
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		$V_{DS}$	100	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 150\text{ }^\circ\text{C}$ )	$T_C = 25\text{ }^\circ\text{C}$	$I_D$	12	A
	$T_C = 70\text{ }^\circ\text{C}$		9.6	
	$T_A = 25\text{ }^\circ\text{C}$		$10^{b,c}$	
	$T_A = 70\text{ }^\circ\text{C}$		$8.3^{b,c}$	
Pulsed Drain Current ( $t = 300\text{ }\mu\text{s}$ )		$I_{DM}$	45	
Continuous Source-Drain Diode Current	$T_C = 25\text{ }^\circ\text{C}$	$I_S$	5.4	
	$T_A = 25\text{ }^\circ\text{C}$		$2.7^{b,c}$	
Single Pulse Avalanche Current	L = 0.1 mH	$I_{AS}$	30	
Avalanche Energy		$E_{AS}$	45	mJ
Maximum Power Dissipation	$T_C = 25\text{ }^\circ\text{C}$	$P_D$	6	W
	$T_C = 70\text{ }^\circ\text{C}$		3.8	
	$T_A = 25\text{ }^\circ\text{C}$		$3^{b,c}$	
	$T_A = 70\text{ }^\circ\text{C}$		$1.9^{b,c}$	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	- 55 to 150	$^\circ\text{C}$

<b>THERMAL RESISTANCE RATINGS</b>					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, d</sup>	$t \leq 10\text{ s}$	$R_{thJA}$	33	42	$^\circ\text{C/W}$
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	16	21	

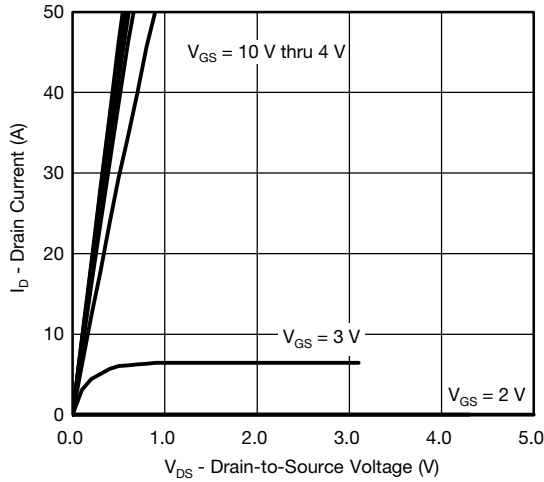
<b>SPECIFICATIONS</b> ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	100			V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$		64		mV/ $^\circ\text{C}$
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 5.8		
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	1.0		2.5	V
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
		$V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$			10	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}, V_{GS} = 10\text{ V}$	30			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 10\text{ A}$			0.012	$\Omega$
		$V_{GS} = 7.5\text{ V}, I_D = 10\text{ A}$			0.013	
		$V_{GS} = 4.5\text{ V}, I_D = 8\text{ A}$			0.014	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 15\text{ V}, I_D = 10\text{ A}$		54		S
<b>Dynamic<sup>b</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$		1970		pF
Output Capacitance	$C_{oss}$			695		
Reverse Transfer Capacitance	$C_{rss}$			62		
Total Gate Charge	$Q_g$	$V_{DS} = 50\text{ V}, V_{GS} = 10\text{ V}, I_D = 8\text{ A}$		44.4	67	nC
		$V_{DS} = 50\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 8\text{ A}$		20.7	31	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 50\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 8\text{ A}$		6.1		
Gate-Drain Charge	$Q_{gd}$	$V_{DS} = 50\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 8\text{ A}$		9.1		
Output Charge	$Q_{oss}$	$V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}$		56	85	
Gate Resistance	$R_g$	$f = 1\text{ MHz}$	0.4	1.1	2.2	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 50\text{ V}, R_L = 5\text{ }\Omega$ $I_D \cong 10\text{ A}, V_{GEN} = 7.5\text{ V}, R_g = 1\text{ }\Omega$		15	30	ns
Rise Time	$t_r$			11	22	
Turn-Off Delay Time	$t_{d(off)}$			31	60	
Fall Time	$t_f$			10	20	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 50\text{ V}, R_L = 5\text{ }\Omega$ $I_D \cong 10\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\text{ }\Omega$		12	24	
Rise Time	$t_r$			10	20	
Turn-Off Delay Time	$t_{d(off)}$			34	65	
Fall Time	$t_f$			10	20	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25\text{ }^\circ\text{C}$			5.4	A
Pulse Diode Forward Current <sup>a</sup>	$I_{SM}$				70	
Body Diode Voltage	$V_{SD}$	$I_S = 5\text{ A}$		0.76	1.1	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 10\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$		42	80	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			40	80	nC
Reverse Recovery Fall Time	$t_a$			19		ns
Reverse Recovery Rise Time	$t_b$			23		

Notes:

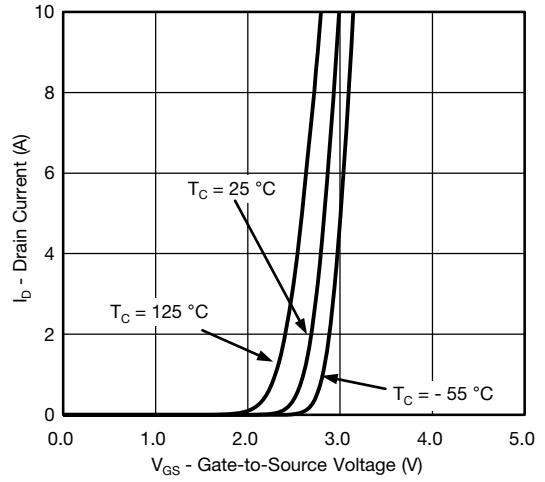
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$   
 b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

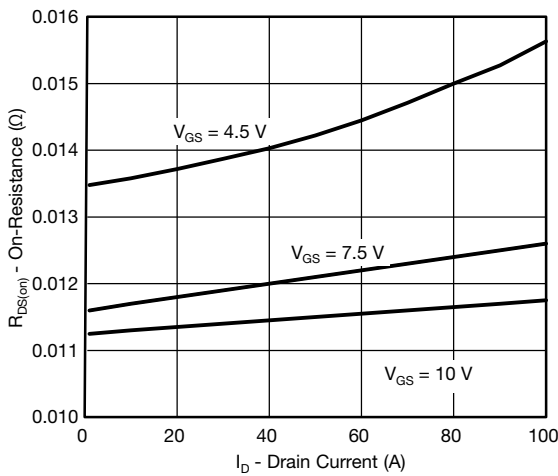
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



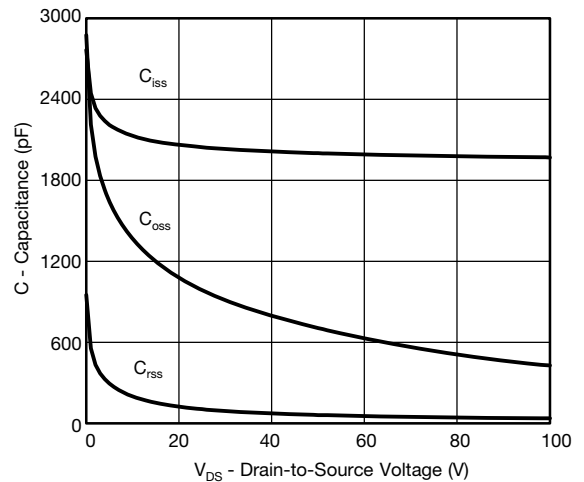
**Output Characteristics**



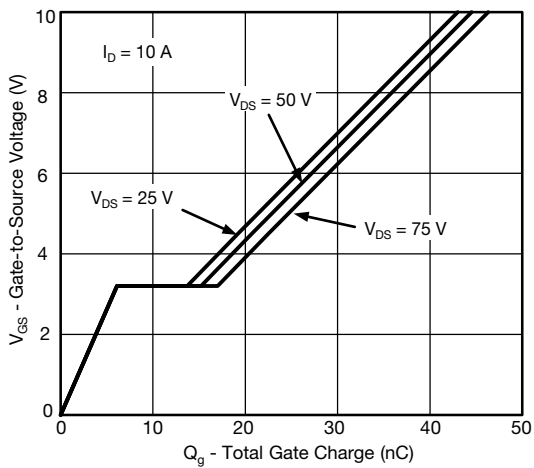
**Transfer Characteristics**



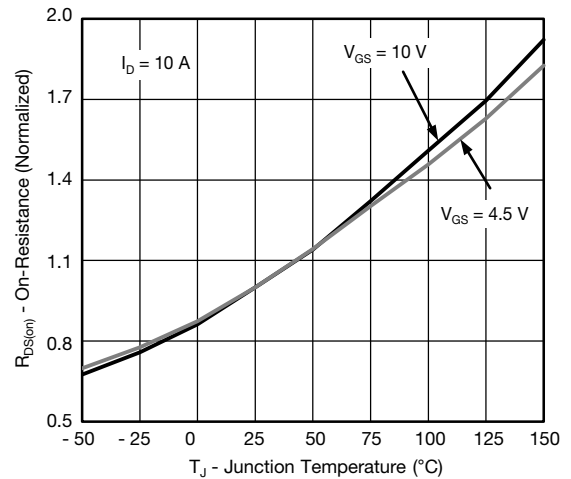
**On-Resistance vs. Drain Current**



**Capacitance**

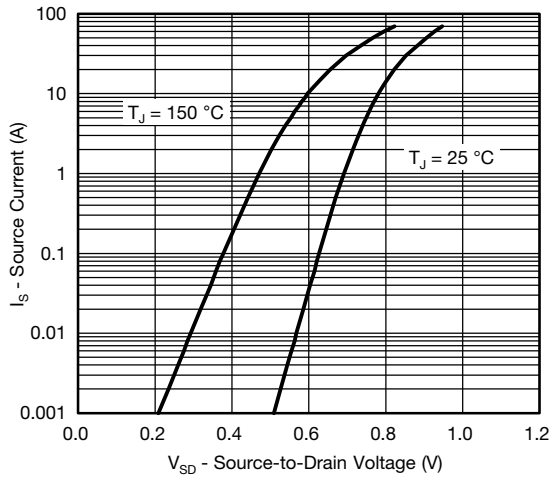


**Gate Charge**

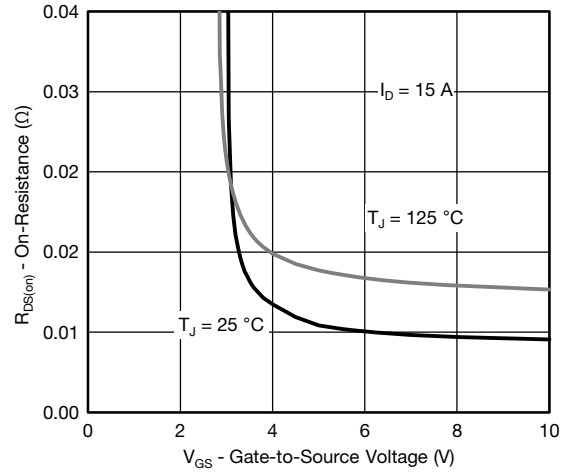


**On-Resistance vs. Junction Temperature**

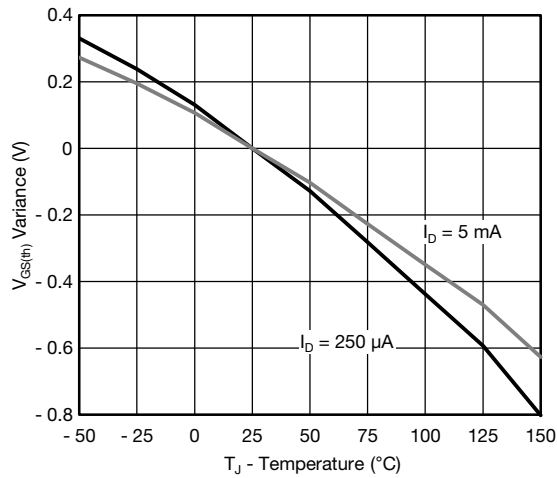
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



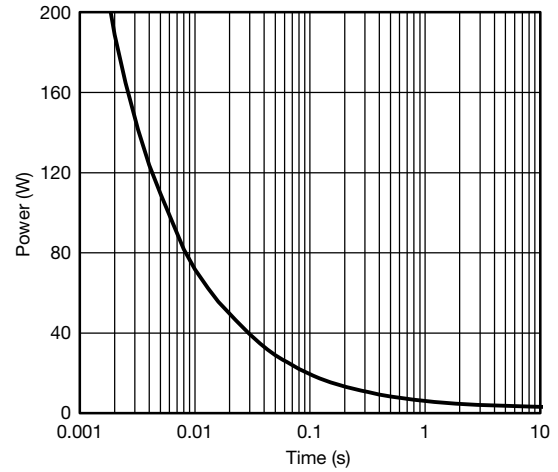
**Source-Drain Diode Forward Voltage**



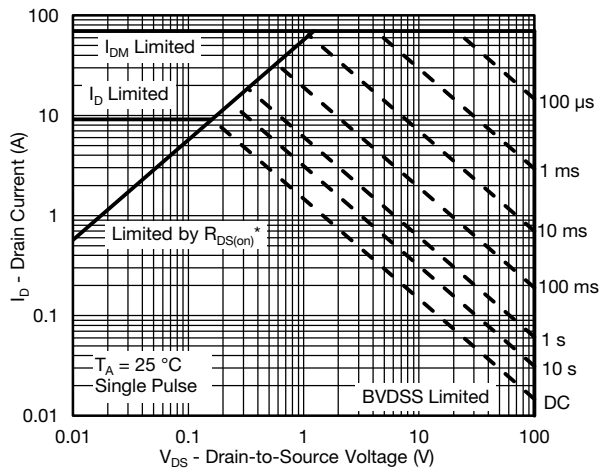
**On-Resistance vs. Gate-to-Source Voltage**



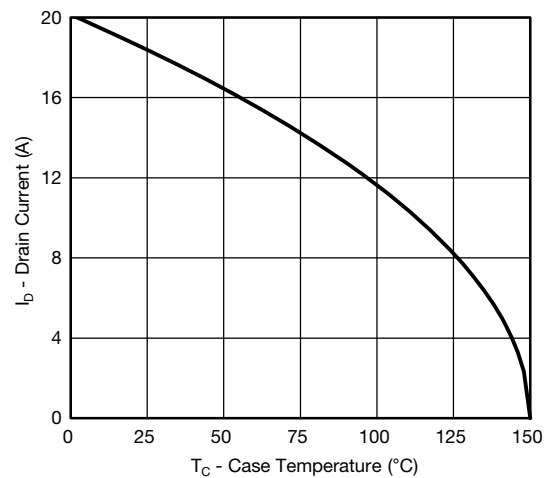
**Threshold Voltage**



**Single Pulse Power, Junction-to-Ambient**



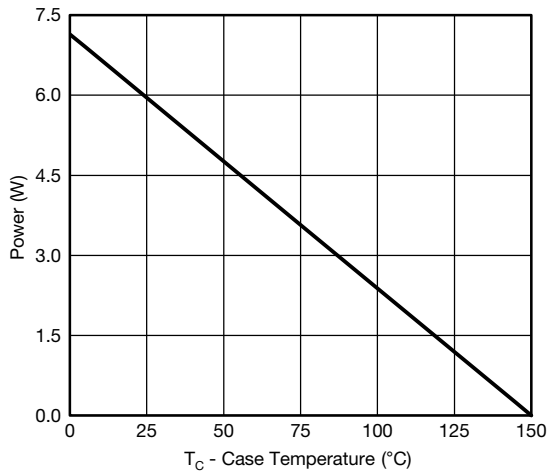
**Safe Operating Area, Junction-to-Ambient**



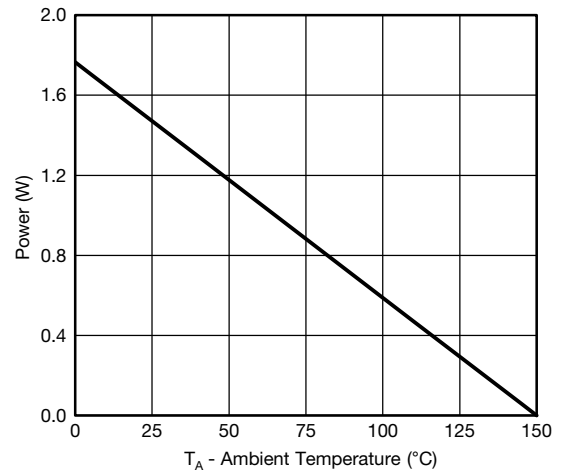
**Current Derating\***

\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

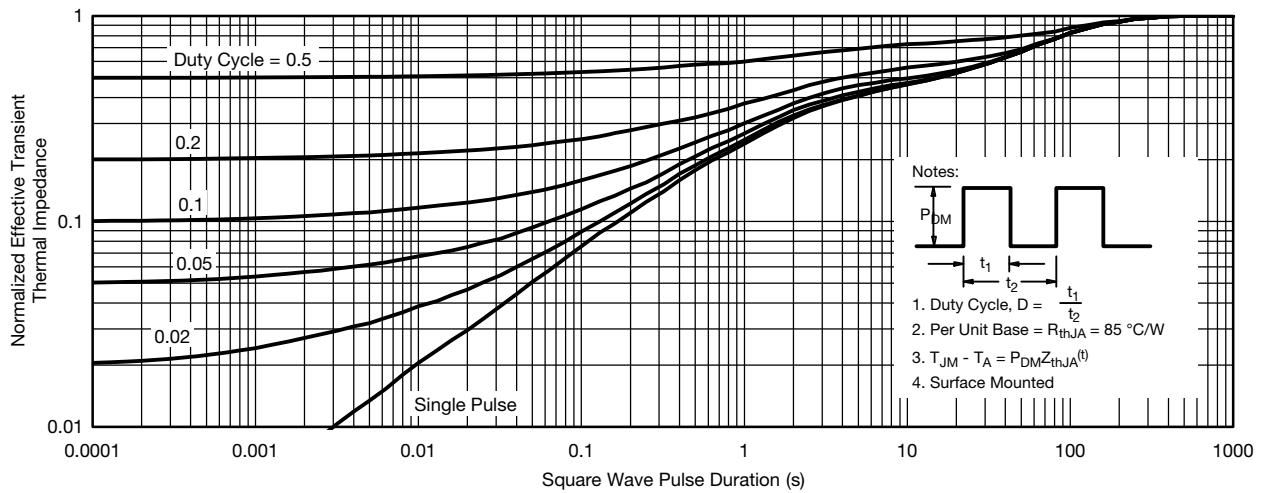
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



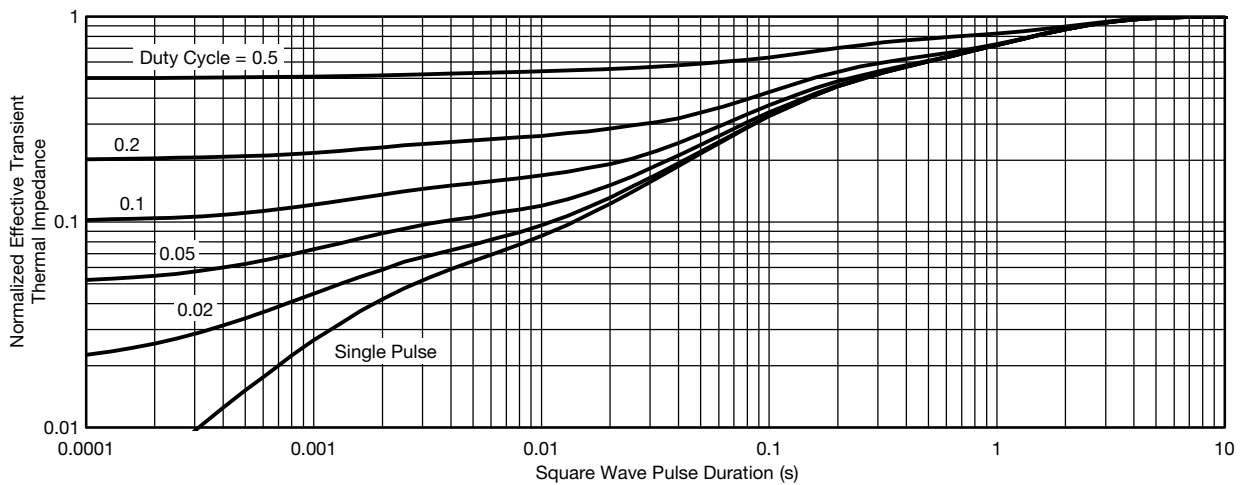
**Power, Junction-to-Foot**



**Power, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Foot**